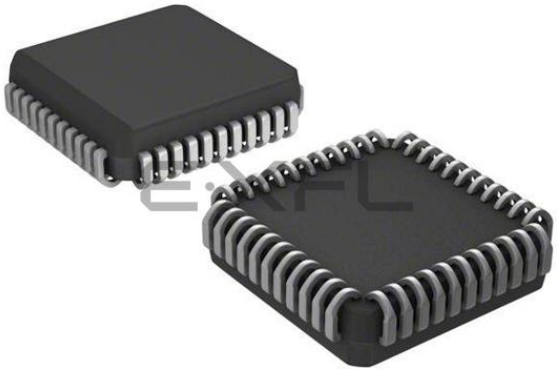

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Details	
Product Status	Obsolete
Core Processor	PIC
Core Size	8-Bit
Speed	33MHz
Connectivity	UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	33
Program Memory Size	4KB (2K x 16)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	232 x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 6V
Data Converters	-
Oscillator Type	External
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	44-LCC (J-Lead)
Supplier Device Package	44-PLCC (16.59x16.59)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic17c42a-33e-l

Table of Contents

For register and module descriptions in this data sheet, device legends show which devices apply to those sections. For example, the legend below shows that some features of only the PIC17C43, PIC17CR43, PIC17C44 are described in this section.

Applicable Devices					
42	R42	42A	43	R43	44

To Our Valued Customers

We constantly strive to improve the quality of all our products and documentation. We have spent an exceptional amount of time to ensure that these documents are correct. However, we realize that we may have missed a few things. If you find any information that is missing or appears in error from the previous version of the PIC17C4X Data Sheet (Literature Number DS30412B), please use the reader response form in the back of this data sheet to inform us. We appreciate your assistance in making this a better document.

To assist you in the use of this document, Appendix C contains a list of new information in this data sheet, while Appendix D contains information that has changed

TABLE 3-1: PINOUT DESCRIPTIONS

Name	DIP No.	PLCC No.	QFP No.	I/O/P Type	Buffer Type	Description
OSC1/CLKIN	19	21	37	I	ST	Oscillator input in crystal/resonator or RC oscillator mode. External clock input in external clock mode.
OSC2/CLKOUT	20	22	38	O	—	Oscillator output. Connects to crystal or resonator in crystal oscillator mode. In RC oscillator or external clock modes OSC2 pin outputs CLKOUT which has one fourth the frequency of OSC1 and denotes the instruction cycle rate.
$\overline{MCLR}$/VPP	32	35	7	I/P	ST	Master clear (reset) input/Programming Voltage (VPP) input. This is the active low reset input to the chip.
						PORTA is a bi-directional I/O Port except for RA0 and RA1 which are input only.
RA0/INT	26	28	44	I	ST	RA0/INT can also be selected as an external interrupt input. Interrupt can be configured to be on positive or negative edge.
RA1/T0CKI	25	27	43	I	ST	RA1/T0CKI can also be selected as an external interrupt input, and the interrupt can be configured to be on positive or negative edge. RA1/T0CKI can also be selected to be the clock input to the Timer0 timer/counter.
RA2	24	26	42	I/O	ST	High voltage, high current, open drain input/output port pins.
RA3	23	25	41	I/O	ST	High voltage, high current, open drain input/output port pins.
RA4/RX/DT	22	24	40	I/O	ST	RA4/RX/DT can also be selected as the USART (SCI) Asynchronous Receive or USART (SCI) Synchronous Data.
RA5/TX/CK	21	23	39	I/O	ST	RA5/TX/CK can also be selected as the USART (SCI) Asynchronous Transmit or USART (SCI) Synchronous Clock.
						PORTB is a bi-directional I/O Port with software configurable weak pull-ups.
RB0/CAP1	11	13	29	I/O	ST	RB0/CAP1 can also be the CAP1 input pin.
RB1/CAP2	12	14	30	I/O	ST	RB1/CAP2 can also be the CAP2 input pin.
RB2/PWM1	13	15	31	I/O	ST	RB2/PWM1 can also be the PWM1 output pin.
RB3/PWM2	14	16	32	I/O	ST	RB3/PWM2 can also be the PWM2 output pin.
RB4/TCLK12	15	17	33	I/O	ST	RB4/TCLK12 can also be the external clock input to Timer1 and Timer2.
RB5/TCLK3	16	18	34	I/O	ST	RB5/TCLK3 can also be the external clock input to Timer3.
RB6	17	19	35	I/O	ST	
RB7	18	20	36	I/O	ST	
						PORTC is a bi-directional I/O Port.
RC0/AD0	2	3	19	I/O	TTL	This is also the lower half of the 16-bit wide system bus in microprocessor mode or extended microcontroller mode. In multiplexed system bus configuration, these pins are address output as well as data input or output.
RC1/AD1	3	4	20	I/O	TTL	
RC2/AD2	4	5	21	I/O	TTL	
RC3/AD3	5	6	22	I/O	TTL	
RC4/AD4	6	7	23	I/O	TTL	
RC5/AD5	7	8	24	I/O	TTL	
RC6/AD6	8	9	25	I/O	TTL	
RC7/AD7	9	10	26	I/O	TTL	

Legend: I = Input only; O = Output only; I/O = Input/Output; P = Power; — = Not Used; TTL = TTL input; ST = Schmitt Trigger input.

5.5 RA0/INT Interrupt

The external interrupt on the RA0/INT pin is edge triggered. Either the rising edge, if INTEDG bit (T0STA<7>) is set, or the falling edge, if INTEDG bit is clear. When a valid edge appears on the RA0/INT pin, the INTF bit (INTSTA<4>) is set. This interrupt can be disabled by clearing the INTE control bit (INTSTA<0>). The INT interrupt can wake the processor from SLEEP. See Section 14.4 for details on SLEEP operation.

5.6 TMR0 Interrupt

An overflow (FFFFh $\rightarrow$ 0000h) in TMR0 will set the T0IF (INTSTA<5>) bit. The interrupt can be enabled/ disabled by setting/clearing the T0IE control bit (INTSTA<1>). For operation of the Timer0 module, see Section 11.0.

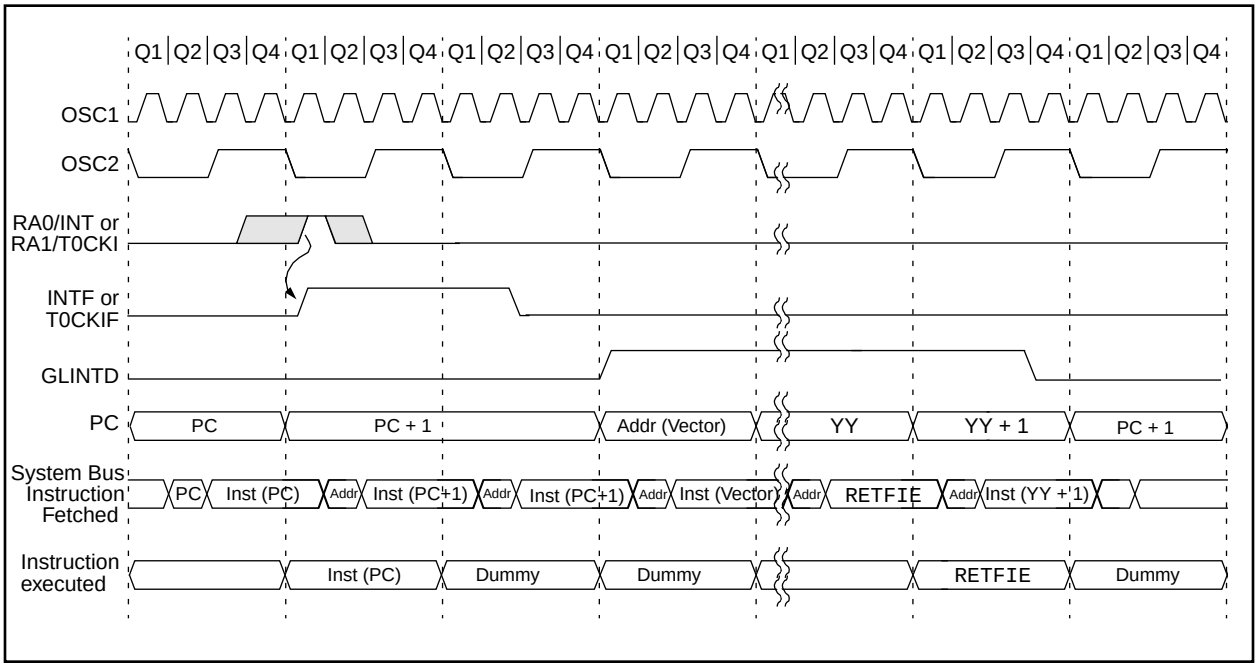
5.7 T0CKI Interrupt

The external interrupt on the RA1/T0CKI pin is edge triggered. Either the rising edge, if the T0SE bit (T0STA<6>) is set, or the falling edge, if the T0SE bit is clear. When a valid edge appears on the RA1/T0CKI pin, the T0CKIF bit (INTSTA<6>) is set. This interrupt can be disabled by clearing the T0CKIE control bit (INTSTA<2>). The T0CKI interrupt can wake up the processor from SLEEP. See Section 14.4 for details on SLEEP operation.

5.8 Peripheral Interrupt

The peripheral interrupt flag indicates that at least one of the peripheral interrupts occurred (PEIF is set). The PEIF bit is a read only bit, and is a bit wise OR of all the flag bits in the PIR register AND'ed with the corresponding enable bits in the PIE register. Some of the peripheral interrupts can wake the processor from SLEEP. See Section 14.4 for details on SLEEP operation.

FIGURE 5-5: INT PIN / T0CKI PIN INTERRUPT TIMING



6.7 Program Counter Module

The Program Counter (PC) is a 16-bit register. PCL, the low byte of the PC, is mapped in the data memory. PCL is readable and writable just as is any other register. PCH is the high byte of the PC and is not directly addressable. Since PCH is not mapped in data or program memory, an 8-bit register PCLATH (PC high latch) is used as a holding latch for the high byte of the PC. PCLATH is mapped into data memory. The user can read or write PCH through PCLATH.

The 16-bit wide PC is incremented after each instruction fetch during Q1 unless:

- Modified by GOTO, CALL, LCALL, RETURN, RETLW, or RETFIE instruction
- Modified by an interrupt response
- Due to destination write to PCL by an instruction

"Skips" are equivalent to a forced NOP cycle at the skipped address.

Figure 6-11 and Figure 6-12 show the operation of the program counter for various situations.

FIGURE 6-11: PROGRAM COUNTER OPERATION

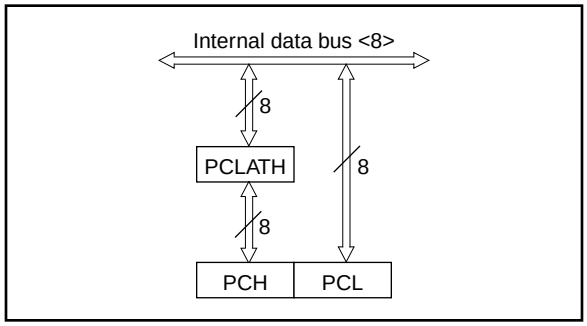
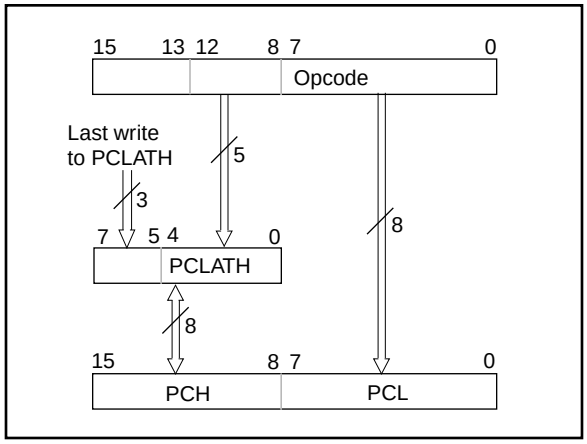


FIGURE 6-12: PROGRAM COUNTER USING THE CALL AND GOTO INSTRUCTIONS



Using Figure 6-11, the operations of the PC and PCLATH for different instructions are as follows:

a) LCALL instructions:
   An 8-bit destination address is provided in the instruction (opcode). PCLATH is unchanged.
   PCLATH → PCH
   Opcode<7:0> → PCL

b) Read instructions on PCL:
   Any instruction that reads PCL.
   PCL → data bus → ALU or destination
   PCH → PCLATH

c) Write instructions on PCL:
   Any instruction that writes to PCL.
   8-bit data → data bus → PCL
   PCLATH → PCH

d) Read-Modify-Write instructions on PCL:
   Any instruction that does a read-write-modify operation on PCL, such as ADDWF PCL.
   Read: PCL → data bus → ALU
   Write: 8-bit result → data bus → PCL
   PCLATH → PCH

e) RETURN instruction:
   PCH → PCLATH
   Stack<MRU> → PC<15:0>

Using Figure 6-12, the operation of the PC and PCLATH for GOTO and CALL instructions is a follows:

CALL, GOTO instructions:
A 13-bit destination address is provided in the instruction (opcode).
Opcode<12:0> → PC <12:0>
PC<15:13> → PCLATH<7:5>
Opcode<12:8> → PCLATH <4:0>

The read-modify-write only affects the PCL with the result. PCH is loaded with the value in the PCLATH. For example, ADDWF PCL will result in a jump within the current page. If PC = 03F0h, WREG = 30h and PCLATH = 03h before instruction, PC = 0320h after the instruction. To accomplish a true 16-bit computed jump, the user needs to compute the 16-bit destination address, write the high byte to PCLATH and then write the low value to PCL.

The following PC related operations do not change PCLATH:

a) LCALL, RETLW, and RETFIE instructions.
b) Interrupt vector is forced onto the PC.
c) Read-modify-write instructions on PCL (e.g. BSF PCL).

Example 8-3 shows the sequence to do a 16 x 16 unsigned multiply. Equation 8-1 shows the algorithm that is used. The 32-bit result is stored in 4 registers RES3:RES0.

EQUATION 8-1: 16 x 16 UNSIGNED MULTIPLICATION ALGORITHM

$$
\begin{aligned}
RES3:RES0 &= ARG1H:ARG1L * ARG2H:ARG2L \\
&= (ARG1H * ARG2H * 2^{16}) + \\
&\quad (ARG1H * ARG2L * 2^{8}) + \\
&\quad (ARG1L * ARG2H * 2^{8}) + \\
&\quad (ARG1L * ARG2L)
\end{aligned}
$$

EXAMPLE 8-3: 16 x 16 MULTIPLY ROUTINE

```
   MOVFP    ARG1L, WREG
   MULWF    ARG2L       ; ARG1L * ARG2L ->
                        ;   PRODH:PRODL
   MOVPF    PRODH, RES1 ;
   MOVPF    PRODL, RES0 ;
;
   MOVFP    ARG1H, WREG
   MULWF    ARG2H       ; ARG1H * ARG2H ->
                        ;   PRODH:PRODL
   MOVPF    PRODH, RES3 ;
   MOVPF    PRODL, RES2 ;
;
   MOVFP    ARG1L, WREG
   MULWF    ARG2H       ; ARG1L * ARG2H ->
                        ;   PRODH:PRODL
   MOVFP    PRODL, WREG ;
   ADDWF    RES1, F     ; Add cross
   MOVFP    PRODH, WREG ;    products
   ADDWFC   RES2, F     ;
   CLRF     WREG, F     ;
   ADDWFC   RES3, F     ;
;
   MOVFP    ARG1H, WREG ;
   MULWF    ARG2L       ; ARG1H * ARG2L ->
                        ;   PRODH:PRODL

   MOVFP    PRODL, WREG ;
   ADDWF    RES1, F     ; Add cross
   MOVFP    PRODH, WREG ;    products
   ADDWFC   RES2, F     ;
   CLRF     WREG, F     ;
   ADDWFC   RES3, F     ;
```

TABLE 9-9: PORTE FUNCTIONS

Name	Bit	Buffer Type	Function
RE0/ALE	bit0	TTL	Input/Output or system bus Address Latch Enable (ALE) control pin.
RE1/$\overline{OE}$	bit1	TTL	Input/Output or system bus Output Enable ($\overline{OE}$) control pin.
RE2/$\overline{WR}$	bit2	TTL	Input/Output or system bus Write ($\overline{WR}$) control pin.

Legend: TTL = TTL input.

TABLE 9-10: REGISTERS/BITS ASSOCIATED WITH PORTE

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-on Reset	Value on all other resets (Note1)
15h, Bank 1	PORTE	—	—	—	—	—	RE2/$\overline{WR}$	RE1/$\overline{OE}$	RE0/ALE	---- -xxx	---- -uuu
14h, Bank 1	DDRE	Data direction register for PORTE								---- -111	---- -111

Legend: x = unknown, u = unchanged, - = unimplemented read as '0'. Shaded cells are not used by PORTE.
Note 1: Other (non power-up) resets include: external reset through $\overline{MCLR}$ and the Watchdog Timer Reset.

FIGURE 13-2: RCSTA REGISTER (ADDRESS: 13h, BANK 0)

R/W - 0	R/W - 0	R/W - 0	R/W - 0	U - 0	R - 0	R - 0	R - x
SPEN	RX9	SREN	CREN	—	FERR	OERR	RX9D
bit7							bit 0

R = Readable bit
W = Writable bit
-n = Value at POR reset
(x = unknown)

bit 7: **SPEN**: Serial Port Enable bit
1 = Configures RA5/RX/DT and RA4/TX/CK pins as serial port pins
0 = Serial port disabled

bit 6: **RX9**: 9-bit Receive Enable bit
1 = Selects 9-bit reception
0 = Selects 8-bit reception

bit 5: **SREN**: Single Receive Enable bit
This bit enables the reception of a single byte. After receiving the byte, this bit is automatically cleared.
Synchronous mode:
1 = Enable reception
0 = Disable reception
Note: This bit is ignored in synchronous slave reception.
Asynchronous mode:
Don't care

bit 4: **CREN**: Continuous Receive Enable bit
This bit enables the continuous reception of serial data.
Asynchronous mode:
1 = Enable reception
0 = Disables reception
Synchronous mode:
1 = Enables continuous reception until CREN is cleared (CREN overrides SREN)
0 = Disables continuous reception

bit 3: **Unimplemented**: Read as '0'

bit 2: **FERR**: Framing Error bit
1 = Framing error (Updated by reading RCREG)
0 = No framing error

bit 1: **OERR**: Overrun Error bit
1 = Overrun (Cleared by clearing CREN)
0 = No overrun error

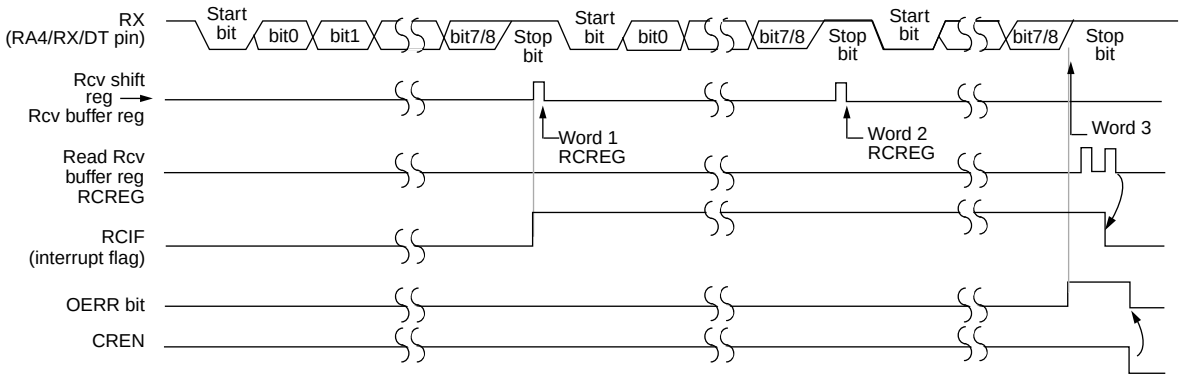
bit 0: **RX9D**: 9th bit of receive data (can be the software calculated parity bit)

Steps to follow when setting up an Asynchronous Reception:

1. Initialize the SPBRG register for the appropriate baud rate.
2. Enable the asynchronous serial port by clearing the SYNC bit and setting the SPEN bit.
3. If interrupts are desired, then set the RCIE bit.
4. If 9-bit reception is desired, then set the RX9 bit.
5. Enable the reception by setting the CREN bit.
6. The RCIF bit will be set when reception completes and an interrupt will be generated if the RCIE bit was set.
7. Read RCSTA to get the ninth bit (if enabled) and FERR bit to determine if any error occurred during reception.
8. Read RCREG for the 8-bit received data.
9. If an overrun error occurred, clear the error by clearing the OERR bit.

Note: To terminate a reception, either clear the SREN and CREN bits, or the SPEN bit. This will reset the receive logic, so that it will be in the proper state when receive is re-enabled.

FIGURE 13-8: ASYNCHRONOUS RECEPTION



Note: This timing diagram shows three words appearing on the RX input. The RCREG (receive buffer) is read after the third word, causing the OERR (overrun) bit to be set.

TABLE 13-6: REGISTERS ASSOCIATED WITH ASYNCHRONOUS RECEPTION

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-on Reset	Value on all other resets (Note1)
16h, Bank 1	PIR	RBIF	TMR3IF	TMR2IF	TMR1IF	CA2IF	CA1IF	TXIF	RCIF	0000 0010	0000 0010
13h, Bank 0	RCSTA	SPEN	RX9	SREN	CREN	—	FERR	OERR	RX9D	0000 -00x	0000 -00u
14h, Bank 0	RCREG	RX7	RX6	RX5	RX4	RX3	RX2	RX1	RX0	xxxx xxxx	uuuu uuuu
17h, Bank 1	PIE	RBIE	TMR3IE	TMR2IE	TMR1IE	CA2IE	CA1IE	TXIE	RCIE	0000 0000	0000 0000
15h, Bank 0	TXSTA	CSRC	TX9	TXEN	SYNC	—	—	TRMT	TX9D	0000 --1x	0000 --1u
17h, Bank 0	SPBRG	Baud rate generator register								xxxx xxxx	uuuu uuuu

Legend: x = unknown, u = unchanged, - = unimplemented read as a '0', shaded cells are not used for asynchronous reception.
Note 1: Other (non power-up) resets include: external reset through $\overline{\text{MCLR}}$ and Watchdog Timer Reset.

13.3 USART Synchronous Master Mode

In Master Synchronous mode, the data is transmitted in a half-duplex manner; i.e. transmission and reception do not occur at the same time: when transmitting data, the reception is inhibited and vice versa. The synchronous mode is entered by setting the SYNC (TXSTA<4>) bit. In addition, the SPEN (RCSTA<7>) bit is set in order to configure the RA5 and RA4 I/O ports to CK (clock) and DT (data) lines respectively. The Master mode indicates that the processor transmits the master clock on the CK line. The Master mode is entered by setting the CSRC (TXSTA<7>) bit.

13.3.1 USART SYNCHRONOUS MASTER TRANSMISSION

The USART transmitter block diagram is shown in Figure 13-3. The heart of the transmitter is the transmit (serial) shift register (TSR). The shift register obtains its data from the read/write transmit buffer TXREG. TXREG is loaded with data in software. The TSR is not loaded until the last bit has been transmitted from the previous load. As soon as the last bit is transmitted, the TSR is loaded with new data from TXREG (if available). Once TXREG transfers the data to the TSR (occurs in one T_{CY} at the end of the current BRG cycle), TXREG is empty and the TXIF (PIR<1>) bit is set. This interrupt can be enabled/disabled by setting/clearing the TXIE bit (PIE<1>). TXIF will be set regardless of the state of bit TXIE and cannot be cleared in software. It will reset only when new data is loaded into TXREG. While TXIF indicates the status of TXREG, TRMT (TXSTA<1>) shows the status of the TSR. TRMT is a read only bit which is set when the TSR is empty. No interrupt logic is tied to this bit, so the user has to poll this bit in order to determine if the TSR is empty. The TSR is not mapped in data memory, so it is not available to the user.

Transmission is enabled by setting the TXEN (TXSTA<5>) bit. The actual transmission will not occur until TXREG has been loaded with data. The first data bit will be shifted out on the next available rising edge of the clock on the RA5/TX/CK pin. Data out is stable around the falling edge of the synchronous clock (Figure 13-10). The transmission can also be started by first loading TXREG and then setting TXEN. This is advantageous when slow baud rates are selected, since BRG is kept in RESET when the TXEN, CREN, and SREN bits are clear. Setting the TXEN bit will start the BRG, creating a shift clock immediately. Normally when transmission is first started, the TSR is empty, so a transfer to TXREG will result in an immediate transfer to the TSR, resulting in an empty TXREG. Back-to-back transfers are possible.

Clearing TXEN during a transmission will cause the transmission to be aborted and will reset the transmitter. The RA4/RX/DT and RA5/TX/CK pins will revert to hi-impedance. If either CREN or SREN are set during a transmission, the transmission is aborted and the RA4/RX/DT pin reverts to a hi-impedance state (for a reception). The RA5/TX/CK pin will remain an output if the CSRC bit is set (internal clock). The transmitter logic is not reset, although it is disconnected from the pins. In order to reset the transmitter, the user has to clear the TXEN bit. If the SREN bit is set (to interrupt an ongoing transmission and receive a single word), then after the single word is received, SREN will be cleared and the serial port will revert back to transmitting, since the TXEN bit is still set. The DT line will immediately switch from hi-impedance receive mode to transmit and start driving. To avoid this, TXEN should be cleared.

In order to select 9-bit transmission, the TX9 (TXSTA<6>) bit should be set and the ninth bit should be written to TX9D (TXSTA<0>). The ninth bit must be written before writing the 8-bit data to TXREG. This is because a data write to TXREG can result in an immediate transfer of the data to the TSR (if the TSR is empty). If the TSR was empty and TXREG was written before writing the “new” TX9D, the “present” value of TX9D is loaded.

Steps to follow when setting up a Synchronous Master Transmission:

1. Initialize the SPBRG register for the appropriate baud rate (see Baud Rate Generator Section for details).
2. Enable the synchronous master serial port by setting the SYNC, SPEN, and CSRC bits.
3. Ensure that the CREN and SREN bits are clear (these bits override transmission when set).
4. If interrupts are desired, then set the TXIE bit (the GLINTD bit must be clear and the PEIE bit must be set).
5. If 9-bit transmission is desired, then set the TX9 bit.
6. Start transmission by loading data to the TXREG register.
7. If 9-bit transmission is selected, the ninth bit should be loaded in TX9D.
8. Enable the transmission by setting TXEN.

Writing the transmit data to the TXREG, then enabling the transmit (setting TXEN) allows transmission to start sooner then doing these two events in the reverse order.

Note:	To terminate a transmission, either clear the SPEN bit, or the TXEN bit. This will reset the transmit logic, so that it will be in the proper state when transmit is re-enabled.

13.4 USART Synchronous Slave Mode

The synchronous slave mode differs from the master mode in the fact that the shift clock is supplied externally at the RA5/TX/CK pin (instead of being supplied internally in the master mode). This allows the device to transfer or receive data in the SLEEP mode. The slave mode is entered by clearing the CSRC (TXSTA<7>) bit.

13.4.1 USART SYNCHRONOUS SLAVE TRANSMIT

The operation of the sync master and slave modes are identical except in the case of the SLEEP mode.

If two words are written to TXREG and then the SLEEP instruction executes, the following will occur. The first word will immediately transfer to the TSR and will transmit as the shift clock is supplied. The second word will remain in TXREG. TXIF will not be set. When the first word has been shifted out of TSR, TXREG will transfer the second word to the TSR and the TXIF flag will now be set. If TXIE is enabled, the interrupt will wake the chip from SLEEP and if the global interrupt is enabled, then the program will branch to interrupt vector (0020h).

Steps to follow when setting up a Synchronous Slave Transmission:

1. Enable the synchronous slave serial port by setting the SYNC and SPEN bits and clearing the CSRC bit.
2. Clear the CREN bit.
3. If interrupts are desired, then set the TXIE bit.
4. If 9-bit transmission is desired, then set the TX9 bit.
5. Start transmission by loading data to TXREG.
6. If 9-bit transmission is selected, the ninth bit should be loaded in TX9D.
7. Enable the transmission by setting TXEN.

Writing the transmit data to the TXREG, then enabling the transmit (setting TXEN) allows transmission to start sooner then doing these two events in the reverse order.

Note:	To terminate a transmission, either clear the SPEN bit, or the TXEN bit. This will reset the transmit logic, so that it will be in the proper state when transmit is re-enabled.

13.4.2 USART SYNCHRONOUS SLAVE RECEPTION

Operation of the synchronous master and slave modes are identical except in the case of the SLEEP mode. Also, SREN is a don't care in slave mode.

If receive is enabled (CREN) prior to the SLEEP instruction, then a word may be received during SLEEP. On completely receiving the word, the RSR will transfer the data to RCREG (setting RCIF) and if the RCIE bit is set, the interrupt generated will wake the chip from SLEEP. If the global interrupt is enabled, the program will branch to the interrupt vector (0020h).

Steps to follow when setting up a Synchronous Slave Reception:

1. Enable the synchronous master serial port by setting the SYNC and SPEN bits and clearing the CSRC bit.
2. If interrupts are desired, then set the RCIE bit.
3. If 9-bit reception is desired, then set the RX9 bit.
4. To enable reception, set the CREN bit.
5. The RCIF bit will be set when reception is complete and an interrupt will be generated if the RCIE bit was set.
6. Read RCSTA to get the ninth bit (if enabled) and determine if any error occurred during reception.
7. Read the 8-bit received data by reading RCREG.
8. If any error occurred, clear the error by clearing the CREN bit.

Note:	To abort reception, either clear the SPEN bit, the SREN bit (when in single receive mode), or the CREN bit (when in continuous receive mode). This will reset the receive logic, so that it will be in the proper state when receive is re-enabled.

15.2 Q Cycle Activity

Each instruction cycle (Tcy) is comprised of four Q cycles (Q1-Q4). The Q cycles provide the timing/designation for the Decode, Read, Execute, Write etc., of each instruction cycle. The following diagram shows the relationship of the Q cycles to the instruction cycle.

The 4 Q cycles that make up an instruction cycle (Tcy) can be generalized as:

Q1: Instruction Decode Cycle or forced NOP

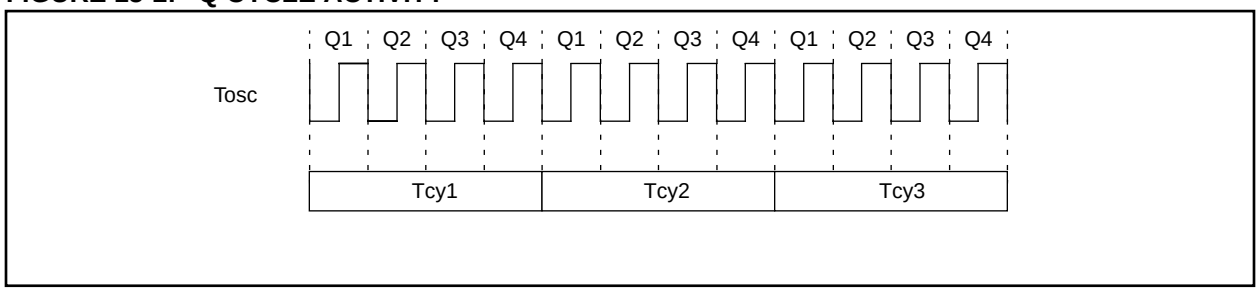
Q2: Instruction Read Cycle or NOP

Q3: Instruction Execute

Q4: Instruction Write Cycle or NOP

Each instruction will show the detailed Q cycle operation for the instruction.

FIGURE 15-2: Q CYCLE ACTIVITY



IORWF **Inclusive OR WREG with f**

Syntax: [*label*] IORWF f,d

Operands: $0 \le f \le 255$
$d \in [0,1]$

Operation: (WREG) .OR. (f) → (dest)

Status Affected: Z

Encoding:

0000	100d	ffff	ffff

Description: Inclusive OR WREG with register 'f'. If 'd' is 0 the result is placed in WREG. If 'd' is 1 the result is placed back in register 'f'.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Execute	Write to destination

Example:
```
IORWF  RESULT, 0
```
Before Instruction
RESULT = 0x13
WREG = 0x91

After Instruction
RESULT = 0x13
WREG = 0x93

LCALL **Long Call**

Syntax: [*label*] LCALL k

Operands: $0 \le k \le 255$

Operation: PC + 1 → TOS;
k → PCL, (PCLATH) → PCH

Status Affected: None

Encoding:

1011	0111	kkkk	kkkk

Description: LCALL allows an unconditional subroutine call to anywhere within the 64k program memory space.

First, the return address (PC + 1) is pushed onto the stack. A 16-bit destination address is then loaded into the program counter. The lower 8-bits of the destination address is embedded in the instruction. The upper 8-bits of PC is loaded from PC high holding latch, PCLATH.

Words: 1

Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'k'	Execute	Write register PCL
Forced NOP	NOP	Execute	NOP

Example:
```
MOVLW  HIGH(SUBROUTINE)
MOVPF  WREG, PCLATH
LCALL  LOW(SUBROUTINE)
```
Before Instruction
SUBROUTINE = 16-bit Address
PC = ?

After Instruction
PC = Address (SUBROUTINE)

Applicable Devices	42	R42	42A	43	R43	44

17.0 PIC17C42 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings †

Ambient temperature under bias ..... -55 to +125˚C

Storage temperature ..... -65˚C to +150˚C

Voltage on V_{DD} with respect to V_{SS} ..... 0 to +7.5V

Voltage on $\overline{MCLR}$ with respect to V_{SS} (Note 2) ..... -0.6V to +14V

Voltage on RA2 and RA3 with respect to V_{SS} ..... -0.6V to +12V

Voltage on all other pins with respect to V_{SS} ..... -0.6V to V_{DD} + 0.6V

Total power dissipation (Note 1) 1.0W

Maximum current out of V_{SS} pin(s) - Total ..... 250 mA

Maximum current into V_{DD} pin(s) - Total ..... 200 mA

Input clamp current, I_{IK} (V_I < 0 or V_I > V_{DD}) ..... ±20 mA

Output clamp current, I_{OK} (V_O < 0 or V_O > V_{DD}) ..... ±20 mA

Maximum output current sunk by any I/O pin (except RA2 and RA3) ..... 35 mA

Maximum output current sunk by RA2 or RA3 pins ..... 60 mA

Maximum output current sourced by any I/O pin ..... 20 mA

Maximum current sunk by PORTA and PORTB (combined) ..... 150 mA

Maximum current sourced by PORTA and PORTB (combined) ..... 100 mA

Maximum current sunk by PORTC, PORTD and PORTE (combined) ..... 150 mA

Maximum current sourced by PORTC, PORTD and PORTE (combined) ..... 100 mA

Note 1: Power dissipation is calculated as follows: $Pdis = V_{DD} \times \{I_{DD} - \sum I_{OH}\} + \sum \{(V_{DD}-V_{OH}) \times I_{OH}\} + \sum(V_{OL} \times I_{OL})$

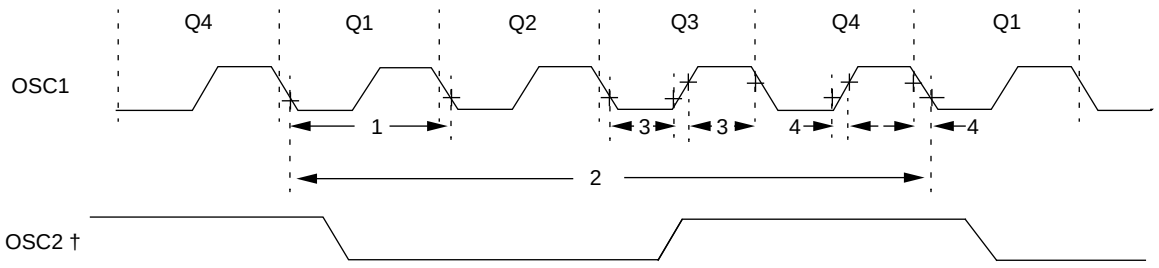
Note 2: Voltage spikes below V_{SS} at the $\overline{MCLR}$ pin, inducing currents greater than 80 mA, may cause latch-up. Thus, a series resistor of 50-100Ω should be used when applying a "low" level to the $\overline{MCLR}$ pin rather than pulling this pin directly to V_{SS}.

† NOTICE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

Applicable Devices	42	R42	42A	43	R43	44

17.4 Timing Diagrams and Specifications

FIGURE 17-2: EXTERNAL CLOCK TIMING



† In EC and RC modes only.

TABLE 17-2: EXTERNAL CLOCK TIMING REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
	Fosc	**External CLKIN Frequency**	DC	—	16	MHz	EC osc mode - PIC17C42-16
		(Note 1)	DC	—	25	MHz	- PIC17C42-25
		Oscillator Frequency	DC	—	4	MHz	RC osc mode
		(Note 1)	1	—	16	MHz	XT osc mode - PIC17C42-16
			1	—	25	MHz	- PIC17C42-25
			DC	—	2	MHz	LF osc mode
1	Tosc	**External CLKIN Period**	62.5	—	—	ns	EC osc mode - PIC17C42-16
		(Note 1)	40	—	—	ns	- PIC17C42-25
		Oscillator Period	250	—	—	ns	RC osc mode
		(Note 1)	62.5	—	1,000	ns	XT osc mode - PIC17C42-16
			40	—	1,000	ns	- PIC17C42-25
			500	—	—	ns	LF osc mode
2	TCY	**Instruction Cycle Time (Note 1)**	160	4/Fosc	DC	ns	
3	TosL, TosH	**Clock in (OSC1) High or Low Time**	10 ‡	—	—	ns	EC oscillator
4	TosR, TosF	**Clock in (OSC1) Rise or Fall Time**	—	—	5 ‡	ns	EC oscillator

† Data in "Typ" column is at 5V, 25˚C unless otherwise stated. These parameters are for design guidance only and are not tested.

‡ These parameters are for design guidance only and are not tested, nor characterized.

Note 1: Instruction cycle period (TCY) equals four times the input oscillator time-base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1 pin.
When an external clock input is used, the "Max." cycle time limit is "DC" (no clock) for all devices.

Applicable Devices	42	R42	42A	43	R43	44

FIGURE 18-13: WDT TIMER TIME-OUT PERIOD vs. VDD

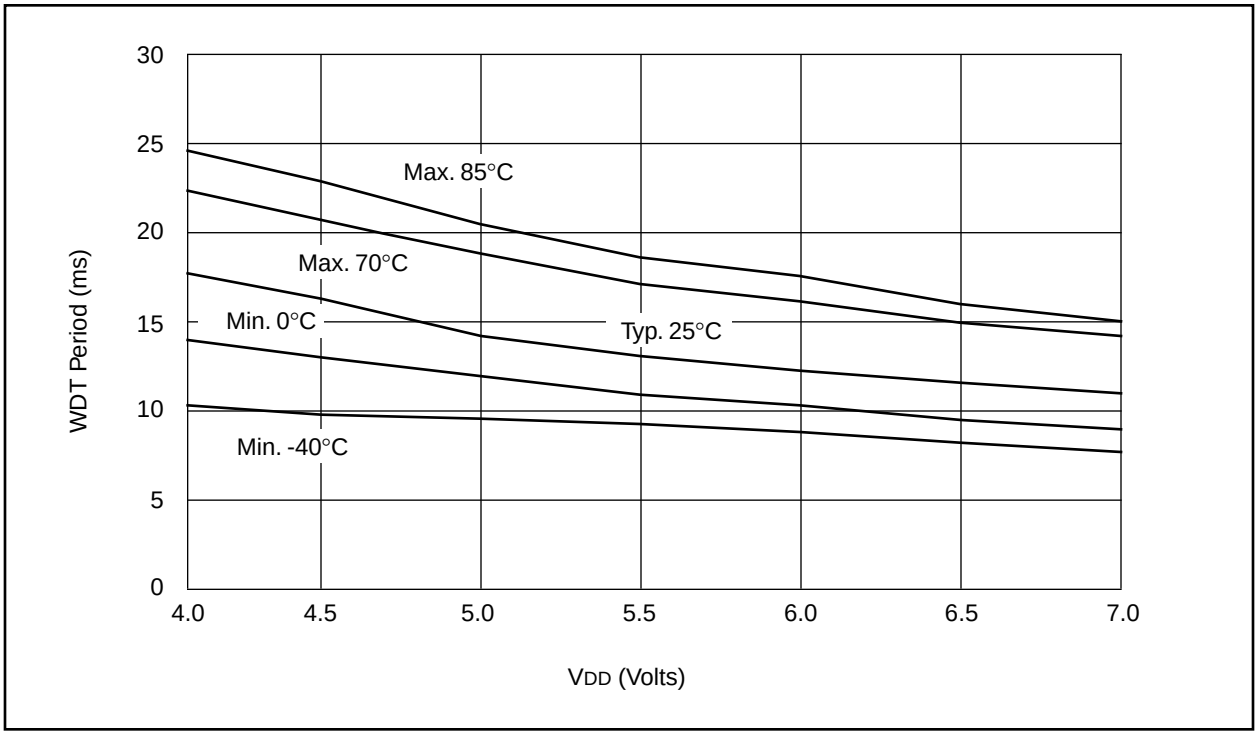
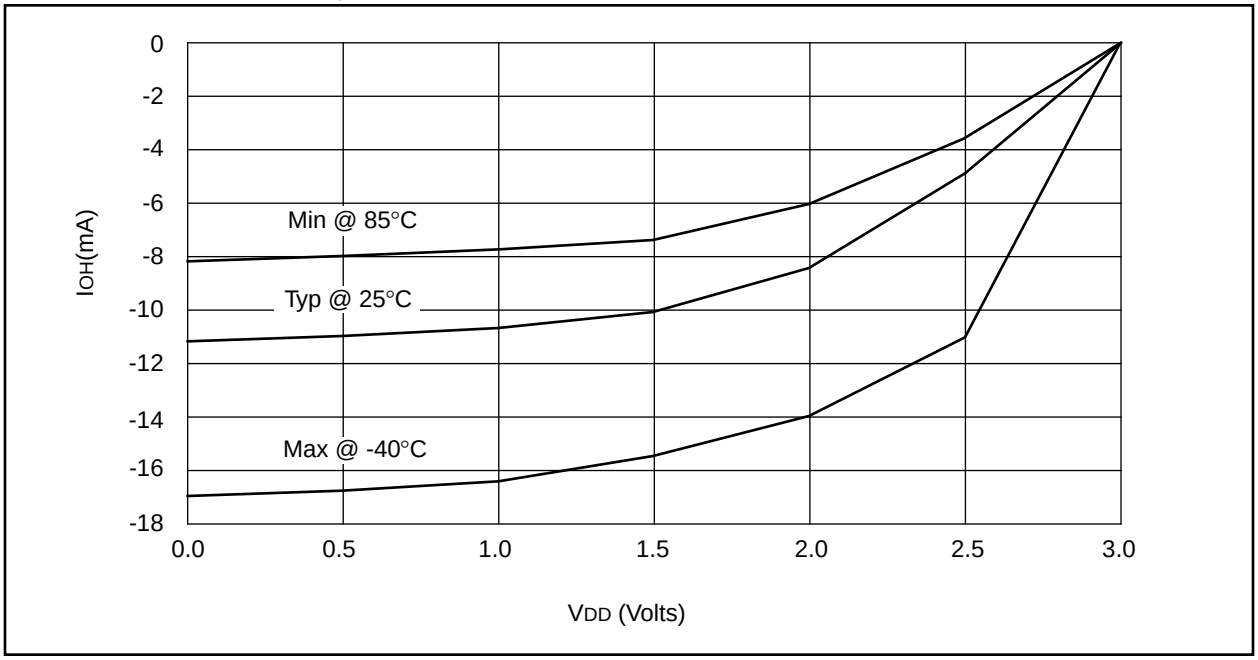


FIGURE 18-14: IOH vs. VOH, VDD = 3V



Applicable Devices	42	R42	42A	43	R43	44

FIGURE 19-11: MEMORY INTERFACE WRITE TIMING (NOT SUPPORTED IN PIC17LC4X DEVICES)

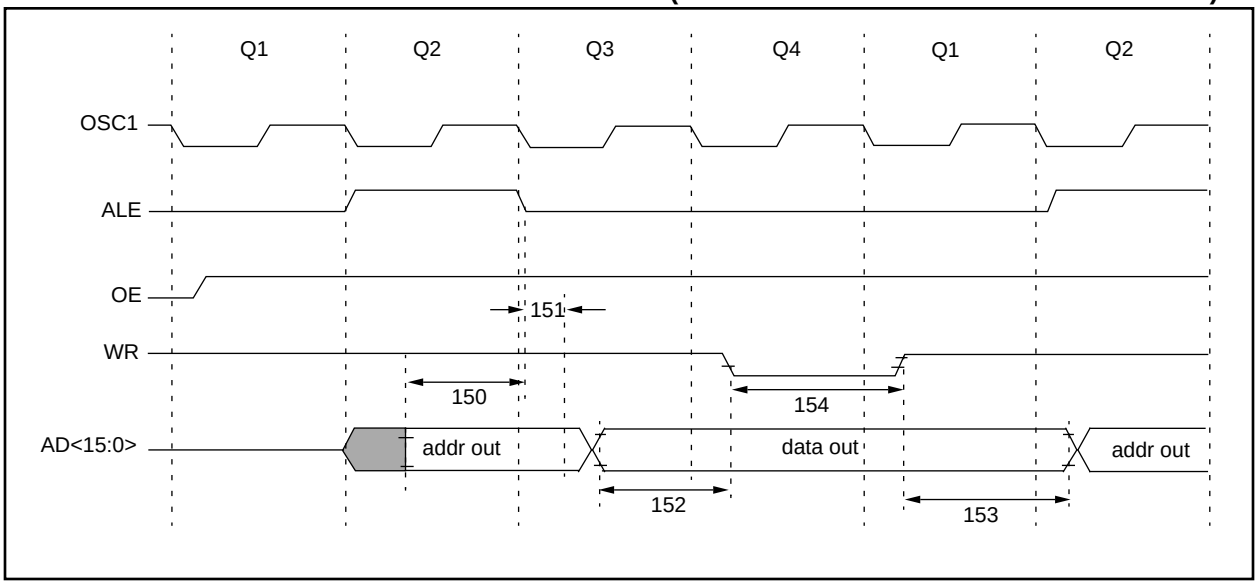


TABLE 19-11: MEMORY INTERFACE WRITE REQUIREMENTS (NOT SUPPORTED IN PIC17LC4X DEVICES)

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
150	TadV2alL	AD<15:0> (address) valid to ALE↓ (address setup time)	0.25Tcy - 10	—	—	ns	
151	TalL2adI	ALE↓ to address out invalid (address hold time)	0	—	—	ns	
152	TadV2wrL	Data out valid to $\overline{WR}$↓ (data setup time)	0.25Tcy - 40	—	—	ns	
153	TwrH2adI	$\overline{WR}$↑ to data out invalid (data hold time)	—	0.25TCY §	—	ns	
154	TwrL	$\overline{WR}$ pulse width	—	0.25TCY §	—	ns	

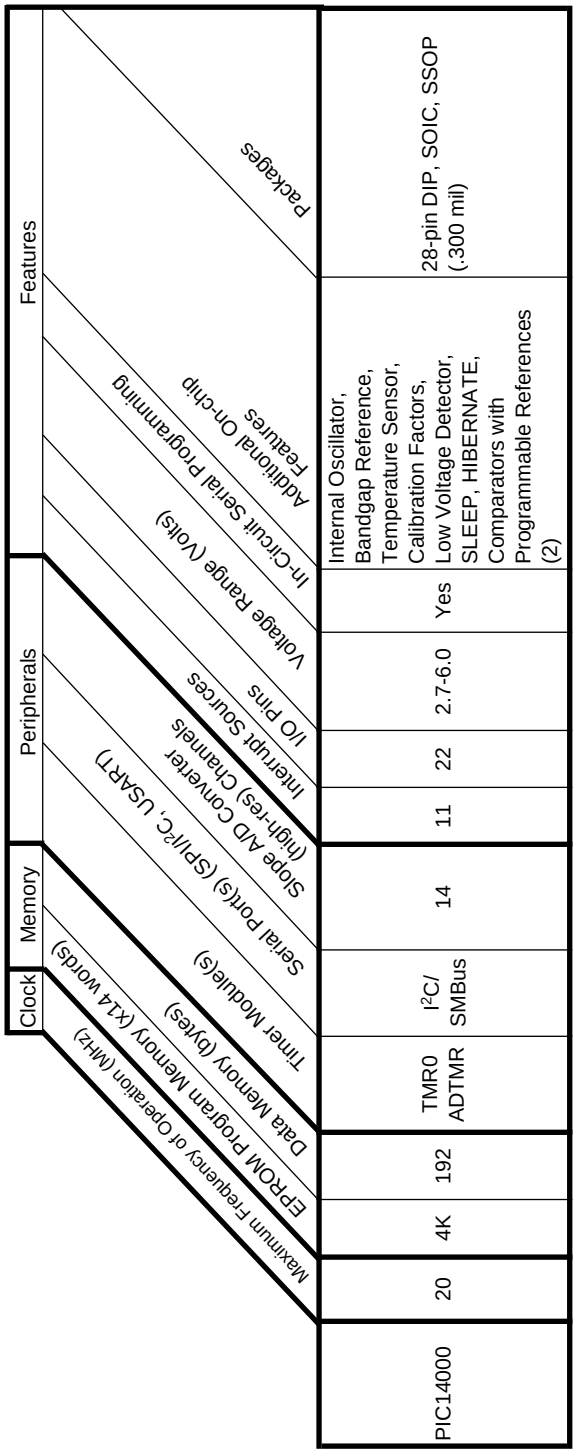
* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

§ This specification ensured by design.

APPENDIX E: PIC16/17 MICROCONTROLLERS

E.1 PIC14000 Devices



S

T

PIC17C4X Product Identification System

To order or to obtain information, e.g., on pricing or delivery, please use the listed part numbers, and refer to the factory or the listed sales offices.

PART NO. – XX X /XX XXX

Pattern:	QTP, SQTP, ROM Code (factory specified) or Special Requirements. Blank for OTP and Windowed devices	
Package:	P	= PDIP
	JW	= Windowed CERDIP
	P	= PDIP (600 mil)
	PQ	= MQFP
	PT	= TQFP
	L	= PLCC
Temperature Range:	–	= 0˚C to +70˚C
	I	= –40˚C to +85˚C
Frequency Range:	08	= 8 MHz
	16	= 16 MHz
	25	= 25 Mhz
	33	= 33 Mhz
Device:	PIC17C44	: Standard Vdd range
	PIC17C44T	: (Tape and Reel)
	PIC17LC44	: Extended Vdd range

Examples

a) PIC17C42 – 16/P Commercial Temp., PDIP package, 16 MHZ, normal V_{DD} limits

b) PIC17LC44 – 08/PT Commercial Temp., TQFP package, 8MHz, extended V_{DD} limits

c) PIC17C43 – 25I/P Industrial Temp., PDIP package, 25 MHz, normal V_{DD} limits

Sales and Support

Products supported by a preliminary Data Sheet may possibly have an errata sheet describing minor operational differences and recommended workarounds. To determine if an errata sheet exists for a particular device, please contact one of the following:

1. Your local Microchip sales office (see below)
2. The Microchip Corporate Literature Center U.S. FAX: (602) 786-7277
3. The Microchip's Bulletin Board, via your local CompuServe number (CompuServe membership NOT required).

Please specify which device, revision of silicon and Data Sheet (include Literature #) you are using.
For latest version information and upgrade kits for Microchip Development Tools, please call 1-800-755-2345 or 1-602-786-7302.

NOTES: